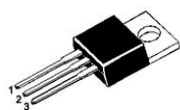
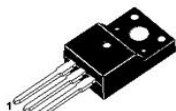




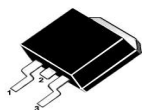
ULTRA LOW VF SCHOTTKY RECTIFIER



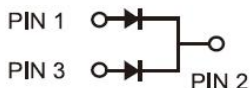
TO-220AB/CT



TO-220F/FCT



TO-263/DC



FEATURES

- Ultra low forward voltage
- High current capability
- High forward surge capability
- Low power losses, High efficiency
- Guarding for over voltage protection



RoHS
COMPLIANT

APPLICATIONS

Low VF Schottky barrier rectifier are designed for high frequency, miniature switched mode power supplies such as adapters ,lighting and on-board DC/DC conerters

Primary Characteristic

| | |
|-------------|-------|
| I_O | 2*20A |
| V_{RRM} | 150V |
| I_{FSM} | 300A |
| V_F | 0.70V |
| $T_{j,max}$ | 150°C |

MECHANICAL DATA

- **Case:** Molded plastic
- **Polarity:** As marked
- **Mounting Position:** Any
- **Molded Plastic:** UL Flammability Classification Rating 94V-0
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Solder bath temperature 275°C maximum,10s per JESD 22-B106

Maximum Ratings at Ta=25°C unless otherwise specified

| Characteristics | Symbol | Value | Unit |
|---|-----------------|-------------|------|
| Maximum Repetitive Peak Reverse Voltage | V_{RRM} | 150 | V |
| Working Peak Reverse Voltage | V_{RWM} | 150 | V |
| Maximum DC Blocking Voltage | V_{DC} | 150 | V |
| Maximum Average Forward Rectified Current | Per Leg | 20 | A |
| | Total | 40 | |
| Peak Forward Surge Current,8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method) | I_{FSM} | 300 | A |
| Operating Temperature Range | T_J | -50 to +150 | °C |
| Storage Temperature Range | T_{STG} | -50 to +150 | °C |
| Typical Thermal Resistance (Note1) TO-220AB,TO-263 TO-220F | $R_{\theta JC}$ | 2 | °C/W |
| | | 4 | |

Note1: Thermal resistance from Junction to case per leg mounted on heatsink.

Electrical Characteristics unless otherwise specified

| Characteristics | | Symbol | Value | | Unit |
|---------------------------------------|----------|--------|-------|------|------|
| Forward Voltage Drop(Note2) | | V_F | Typ. | Max. | V |
| at $I_F=5A$ | TA=25°C | | 0.57 | - | |
| | TA=125°C | | 0.5 | - | |
| at $I_F=10A$ | TA=25°C | | 0.73 | - | |
| | TA=125°C | | 0.6 | - | |
| at $I_F=20A$ | TA=25°C | | 1.02 | 1.2 | |
| | TA=125°C | | 0.7 | - | |
| Maximum Reverse Current at $V_R=150V$ | TA=25°C | | I_R | 5 | |
| | TA=125°C | 5 | | - | mA |

Note2:Pulse test: 300 µs pulse width, 1 % duty cycle



RATINGS AND CHARACTERISTIC CURVES

FIG. 1 MAXIMUM FORWARD CURRENT DERATING CURVE

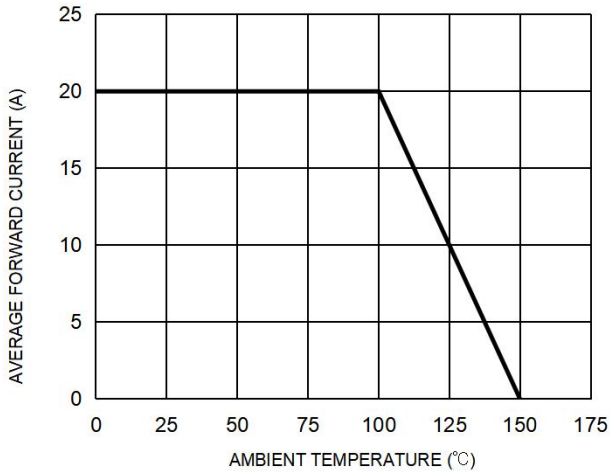


FIG. 2 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT PER LEG

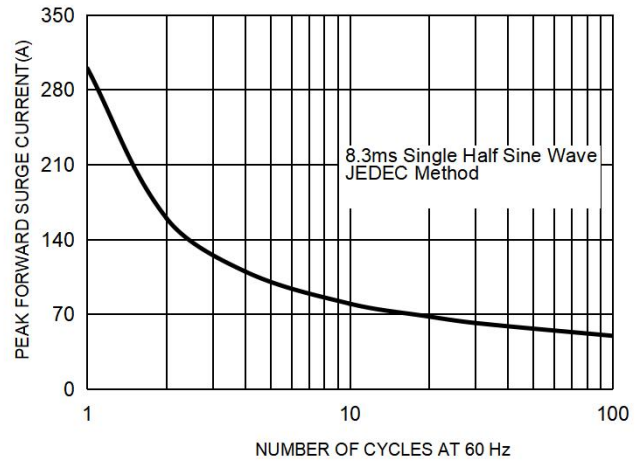


FIG. 3 TYPICAL FORWARD CHARACTERISTICS PER LEG

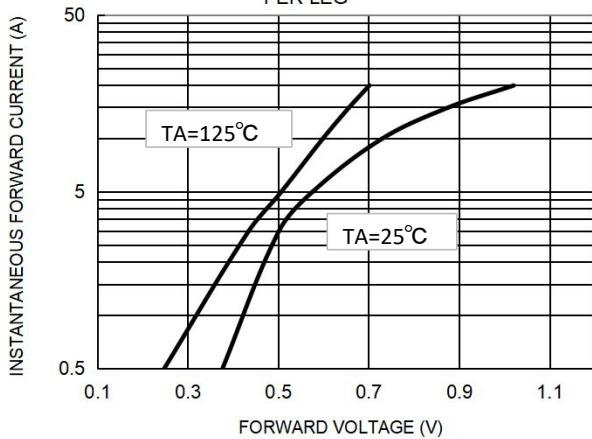
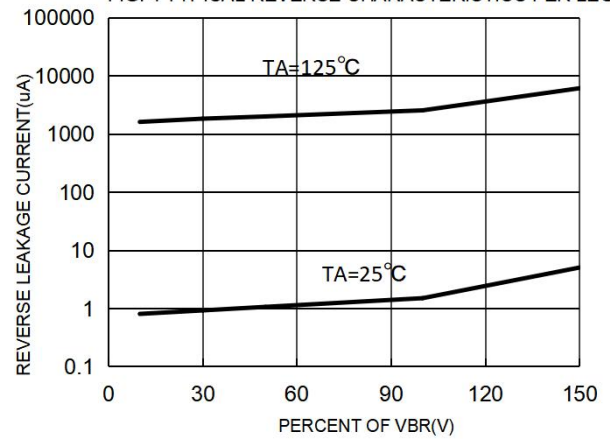


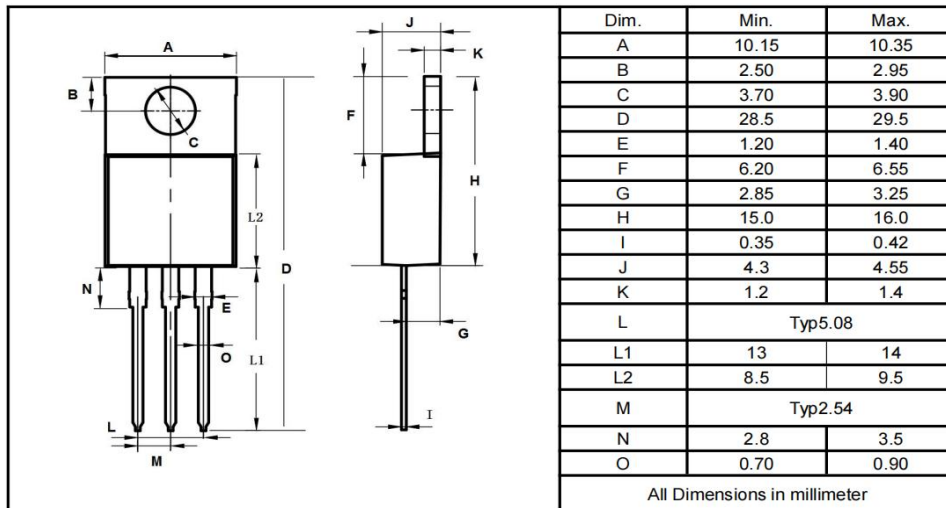
FIG. 4 TYPICAL REVERSE CHARACTERISTICS PER LEG



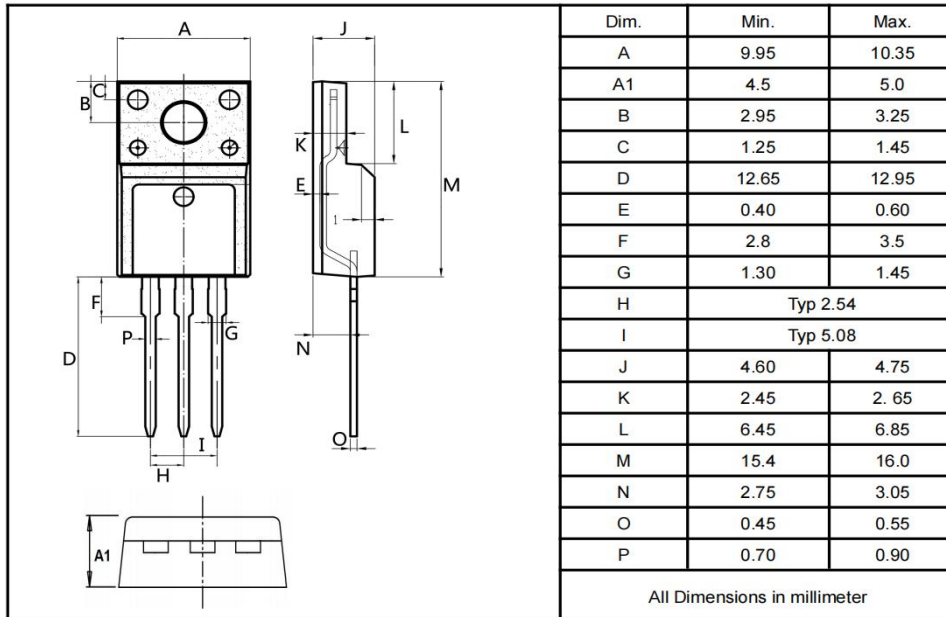


Package Outline Dimensions millimeters

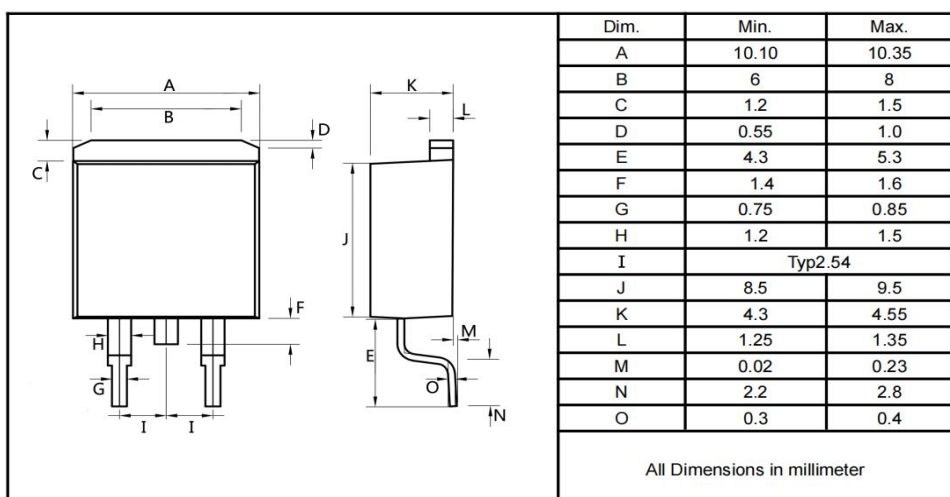
TO-220AB



TO-220F



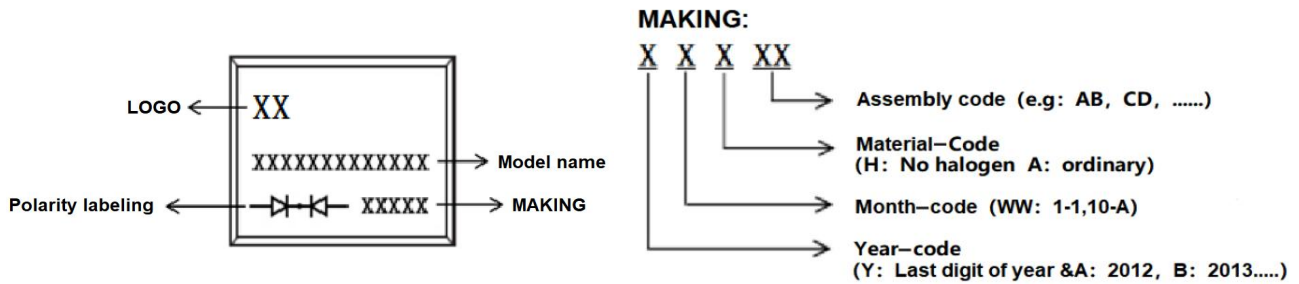
TO-263





SBT40U150CT/FCT/DC

Marking on the body



Ordering information

| Part Number | Package | Unit Weight | Base Quantity | Delivery mode |
|---------------|----------|---------------|----------------|----------------------------|
| SBT40U150CT | TO-220AB | 0.07oz(1.96g) | 50 pcs / tube | 1000pcs/box 5000pcs/carton |
| SBT40U150FCT | TO-220F | 0.06oz(1.74g) | 50 pcs / tube | 1000pcs/box 5000pcs/carton |
| SBT40U150DC | TO-263 | 0.04oz(1.16g) | 50 pcs / tube | 1000pcs/box 5000pcs/carton |
| SBT40U150DC-R | TO-263 | 0.04oz(1.16g) | 800 pcs / reel | 1600pcs/box 8000pcs/carton |

Note: For Halogen Free molding compound, add "H" suffix to part number above.

packing instruction

| PKG | 最小包装 | 内盒 | 外箱 |
|-------------------------------|----------|-----------|-----------|
| TO-220AB TO-220F TO-263 | | | |
| | 50pcs/管 | 1000pcs/盒 | 5000pcs/箱 |
| TO-263-R | | | |
| | 800pcs/盘 | 1600pcs/盒 | 8000pcs/箱 |

Notice

1. All product, product specifications and data are subject to change without notice to improve. The right to explain is owned by LINGXUN electronics company.

2. Confirm that operation temperature is within the specified range described in the product specification. Avoid applying power exceeding normal rated power;

exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

3. LINGXUN electronics shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.